

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 6,833,727 B2
APPLICATION NO. : 10/803294
DATED : December 21, 2004
INVENTOR(S) : Farnworth et al.

Page 1 of 2

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

- Col. 1, line 57, delete "circuitry" after "grated" and insert --circuitry--.
- Col. 1, line 64, delete "fabricator" after "chip" and insert --fabrication--.
- Col. 2, line 23, delete "search" after "or" and insert --scratch--.
- Col. 3, line 16, delete "or" before "engaging" and insert --of--.
- Col. 3 line 59, delete "vet" after "with" and insert --yet--.
- Col. 3, line 61, delete "packs on a semiconductor Substrate having Integrated" before "cir-" and insert -- pads on a semiconductor substrate having integrated--.
- Col. 4, line 30, insert --in-- after "lines".
- Col. 4, line 33, delete "s5" after "such".
- Col. 4, line 34, delete "tie" after "within" and insert --the--.
- Col. 4, line 36, delete "test" after "for" and insert --test--.
- Col. 4, line 40, delete "es" after "blocks/lines".
- Col. 4, line 43, delete "entire" before "with" and insert --entirely--.
- Col. 4, line 58, delete "trough H2O" before "while" and insert --through H₂O--.
- Col. 4, line 61, delete "stepping" after "such" and insert --stripping--.
- Col. 4, line 66, insert --HF-- after "temperature".
- Col. 5, line 13, delete "etc." after "isotropic" and insert --etch--.
- Col. 5. line 23, delete "numbed" after "are" and insert --numbered--.
- Col. 5, line 30, delete "sand" after "tip 58" and insert --and--.
- Col. 5, line 36, delete "apparatus." after "ing" and insert --apexes--.
- Col. 5, line 57, delete "conducted" after "be" and insert --conducted--.
- Col. 5, line 60, delete "rip" after "to" and insert --tip--.
- Col. 5, line 61, delete "deed arid" after "microns" and insert --deep and--.
- Col. 5, line 67, delete circuit" after "appropriate" and insert --circuitry--.
- Col. 6, line 7, delete "step" after "applies" and insert --atop--.
- Col. 6, line 11, delete "projection" after "exposed" and insert --projecting--.
- Col. 6, line 20, delete "11" after "substrate" and insert --12--.
- Col. 6, line 23, delete "desorption" before "only" and insert --deposition--.
- Col. 6, line 36, delete "photoresist:" after "provide" and insert --photoresist--.
- Col. 6, line 46, delete "tested" after "being" and insert --tested--.
- Col. 6, line 56, delete "or" after "confines" and insert --of--.
- Col. 6, line 60, delete "on-half" after "approximately" and insert --one-half--.

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Col. 7, line 15, delete "is" after "electrically".
Col. 7, line 18, delete "the" after "is" and insert --then--.
Col. 7, line 25, delete "electrodes as" after "as" and insert --electroless--.
Col. 7, line 30, delete "17" after "FIG." and insert --17--.
Col. 7, line 36, delete "electrodes" after "which" and insert --electroless--.
Col. 7, line 42, delete "electrodes" before "deposition" and insert --electroless--.
Col. 7, line 47, delete "he" after "rendering" and insert --the--.
Col. 7, line 52, delete layer." After "ation" and insert --layer--.

Signed and Sealed this

First Day of August, 2006

A handwritten signature in black ink, reading "Jon W. Dudas". The signature is stylized, with the first name "Jon" and last name "Dudas" clearly legible, and "W." in the middle.

JON W. DUDAS
Director of the United States Patent and Trademark Office